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**Geometrical product specifications  
(GPS) — Surface texture: Areal —  
Part 607:  
Nominal characteristics of non-contact  
(confocal microscopy) instruments**

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*Spécification géométrique des produits (GPS) — État de surface:  
Surfacique —  
Partie 607: Caractéristiques nominales des instruments sans contact  
(microscopie confocale)*

[ISO 25178-607:2019](https://standards.iteh.ai/catalog/standards/sist/60342a3a-97f6-4d29-b2cd-08574b6abc6f/iso-25178-607-2019)

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## Foreword

ISO (the International Organization for Standardization) is a worldwide federation of national standards bodies (ISO member bodies). The work of preparing International Standards is normally carried out through ISO technical committees. Each member body interested in a subject for which a technical committee has been established has the right to be represented on that committee. International organizations, governmental and non-governmental, in liaison with ISO, also take part in the work. ISO collaborates closely with the International Electrotechnical Commission (IEC) on all matters of electrotechnical standardization.

The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular, the different approval criteria needed for the different types of ISO documents should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see [www.iso.org/directives](http://www.iso.org/directives)).

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. ISO shall not be held responsible for identifying any or all such patent rights. Details of any patent rights identified during the development of the document will be in the Introduction and/or on the ISO list of patent declarations received (see [www.iso.org/patents](http://www.iso.org/patents)).

Any trade name used in this document is information given for the convenience of users and does not constitute an endorsement.

For an explanation of the voluntary nature of standards, the meaning of ISO specific terms and expressions related to conformity assessment, as well as information about ISO's adherence to the World Trade Organization (WTO) principles in the Technical Barriers to Trade (TBT) see [www.iso.org/iso/foreword.html](http://www.iso.org/iso/foreword.html).

This document was prepared by Technical Committee ISO/TC 213, *Dimensional and geometrical product specifications and verification*.

A list of all parts in the ISO 25178 series can be found on the ISO website.

Any feedback or questions on this document should be directed to the user's national standards body. A complete listing of these bodies can be found at [www.iso.org/members.html](http://www.iso.org/members.html).

## Introduction

This document is a geometrical product specification (GPS) standard and is to be regarded as a general GPS standard (see ISO 14638). It influences the chain link F of the chains of standards on areal surface texture and profile surface texture.

The ISO/GPS matrix model given in ISO 14638 gives an overview of the ISO/GPS system of which this document is a part. The fundamental rules of ISO/GPS given in ISO 8015 apply to this document and the default decision rules given in ISO 14253-1 apply to the specifications made in accordance with this document, unless otherwise indicated.

For more detailed information of the relation of this document to other standards and the GPS matrix model, see [Annex D](#).

This document describes the metrological characteristics of confocal microscopes designed for the measurement of surface topography maps.

For detailed information on the confocal microscopy technique, see [Annex A](#) and [Annex B](#).

NOTE Portions of this document, particularly the informative sections, describe patented systems and methods. This information is provided only to assist users in understanding the operating principles of confocal microscopy. This document is not intended to establish priority for any intellectual property, nor does it imply a license to proprietary technologies described herein.

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# Geometrical product specifications (GPS) — Surface texture: Areal —

## Part 607: Nominal characteristics of non-contact (confocal microscopy) instruments

### 1 Scope

This document describes the influence quantities and instrument characteristics of confocal microscopy systems for areal measurement of surface topography. Because surface profiles can be extracted from surface topography images, the methods described in this document can be applied to profiling measurements as well.

### 2 Normative references

There are no normative references in this document.

### 3 Terms and definitions (standards.iteh.ai)

For the purposes of this document, the terms and definitions given in ISO 25178-600 and the following apply.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- ISO Online browsing platform: available at <https://www.iso.org/obp>
- IEC Electropedia: available at <http://www.electropedia.org/>

#### 3.1

##### **confocal microscopy**

measurement method wherein the localization of optically sectioned images during an axial scan through the focus of a microscope's objective provides a means to determine an areal surface topography image

Note 1 to entry: See also ISO 25178-6:2010, 3.3.6.

Note 2 to entry: Confocal microscopes produce optically sectioned images by restricting the illumination onto the sample and through the detection system by means of a pattern, scanning this pattern in-plane to fill the image (see also [Figure B.1](#)).

Note 3 to entry: Illumination and detection patterns could be one or several points, slits or any order of structures, that effectively reduce the illuminated area of the surface. The geometry of these patterns influences the evaluation of the sectioned images and has direct influence on the metrological characteristics of the instrument.

Note 4 to entry: The difference between a confocal point sensor and a confocal microscope is defined by the in-plane scanning scheme. In the confocal microscope one or multiple parallel working light paths scan the surface. This is realized with various optical elements. In contrast, the single point confocal probe scans only one point on the sample at a time by moving either the sample or the probe. A single point confocal chromatic probe arrangement is described in ISO 25178-602:2010, Annex B.

Note 5 to entry: [Table 1](#) compiles alternative terms that conform at least in part to the above definition.

**Table 1 — Examples of alternative terms sometimes used for confocal microscope**

Acronym	Term
ICM	imaging confocal microscope
LSCM	laser-scanning <sup>a</sup> confocal microscope (see also <a href="#">A.2</a> )
CLSM	confocal laser-scanning <sup>a</sup> microscope (same method as LSCM)
CSLM	confocal-scanning laser microscope (same method as LSCM)
LSM	laser-scanning <sup>a</sup> microscope (same method as LSCM)
DSCM	disc-scanning confocal microscope (see also <a href="#">A.3</a> )
PACM or PAM	programmable array confocal microscope or programmable array microscope (see also <a href="#">A.4</a> )
MSCM	microdisplay scanning confocal microscope (same method as PACM)
RSOM	real-time scanning optical microscope
CSOM	confocal-scanning optical microscope

<sup>a</sup> The term 'laser-scanning microscope' has also been used to refer to laser-based scanning probes with height sensors, such as triangulation or dynamic focus, which are different from the confocal methods described here.

### 3.2 illumination pattern

arrangement of single or repetitive structures placed on a conjugate image position of the microscope's objective (typically the field diaphragm position), restricting the illuminated parts on the sample

Note 1 to entry: The illumination pattern can be a single pinhole, equally spaced pinholes on a grid, slits, parallel slits or any other pattern that effectively reduces the amount of illuminated area.

### 3.3 detection pattern

arrangement of single or repetitive structures placed on a conjugate image position of the microscope's objective, blocking the out-of-focus light reflected from the surface and from previously illuminated parts

Note 1 to entry: The illumination and detection patterns need not have the same geometry.

### 3.4 in-plane scanning

mechanical or optical displacement of the illumination and/or detection patterns to fulfil an optical section image

Note 1 to entry: [Annex A](#) describes the principle of in-plane scanning for typical confocal arrangements.

### 3.5 axial scan

mechanical or optical displacement between the sample under inspection and the imaging optics

Note 1 to entry: The imaging optics is nominally parallel to the axial scan axis of the microscope.

### 3.6 axial scan length

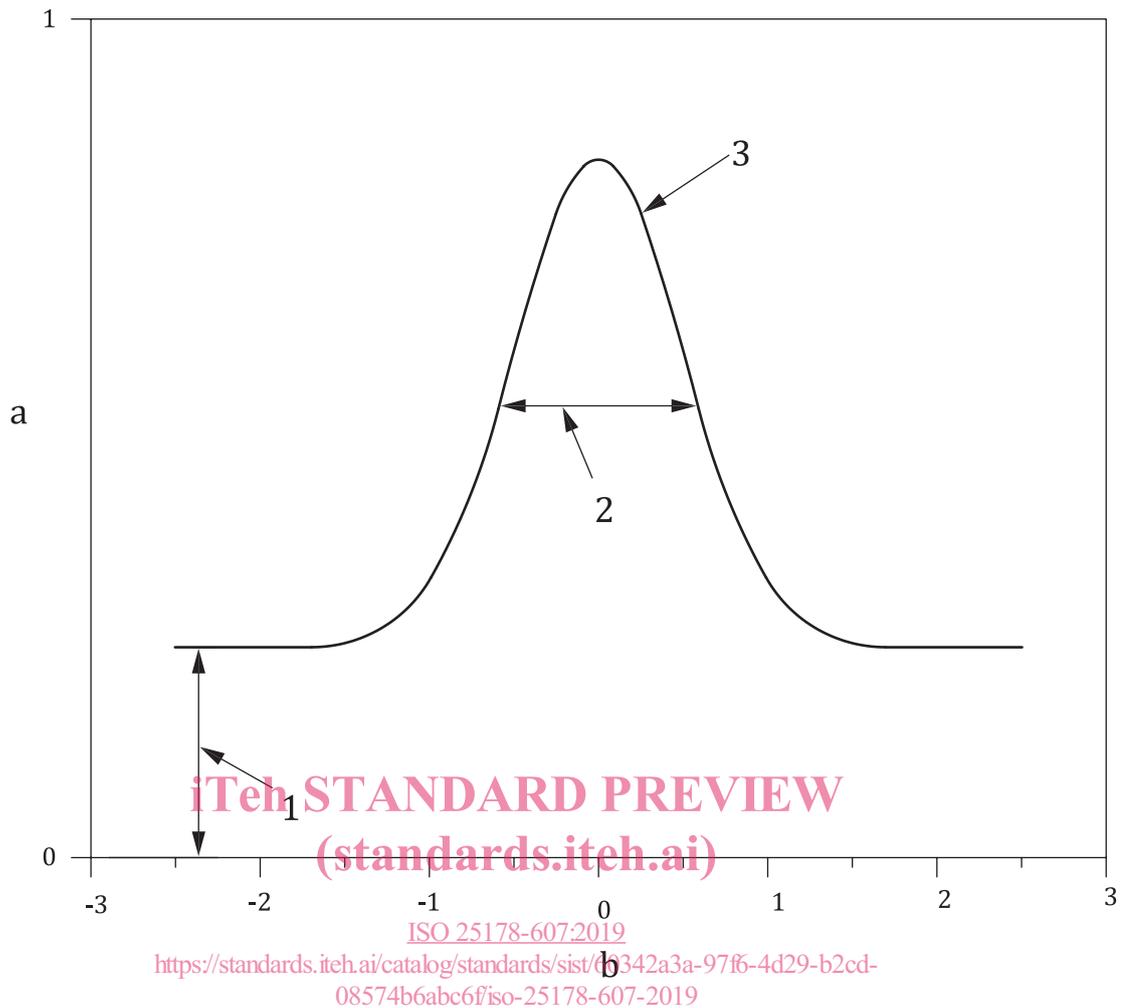
total range travelled by the confocal microscope axial scan, usually the total displacement between the sample and the microscope's objective translated along its optical axis during data acquisition

Note 1 to entry: This parameter might be limited by the overall range of the axial scanner, but is generally a parameter chosen by the operator taking account of the height range of the surface topography.

### 3.7 axial response

signal recorded for an individual image point of the confocal image as a function of the axial scan position

Note 1 to entry: See [Figure 1](#).

**Key**

- a normalized detector signal
- b z-height
- 1 background offset
- 2 full width at half maximum
- 3 axial response

**Figure 1 — Schematic axial response signal****3.8****full width at half maximum****FWHM** $\Delta_{z-HM}$ 

region of the axial response symmetrical to the maximum peak where the signal falls to one-half of the maximum peak signal

Note 1 to entry: The FWHM is used as a metric (or estimator) of the thickness of the optically sectioned slice.

**3.9****maximum signal position**

position of the axial scan where the amplitude of the axial response is maximum

### 3.10

#### **background offset**

value of the axial response for axial positions far from the maximum signal position

Note 1 to entry: The background offset might be caused by residual reflected and scattered light within the instrument and from the sample, “cross talking” between pinholes and incomplete sectioning behaviour of the light path.

Note 2 to entry: Methods exist which reduce or make use of background offset effects.

### 3.11

#### **axial steps**

distance between two consecutive confocal images during an axial scan

### 3.12

#### **confocal imaging rate**

number of confocal images per second provided by a confocal microscope without axial scan

### 3.13

#### **axial scanning rate**

number of confocal images per second provided by a confocal microscope during an axial scan, expressed as the number of acquired plane sections per second

Note 1 to entry: The axial scanning rate might be equal to or lower than the confocal imaging rate depending on the scanning hardware used and the processing algorithms.

### 3.14

#### **flatness calibration surface**

reference surface used to measure and adjust for the microscope flatness error

Note 1 to entry: The calibration surface is typically an optically flat single surface mirror (flatness  $\leq \lambda/10$  and roughness average  $R_a < 0,5$  nm).

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### 3.15

#### **confocal peak location algorithm**

algorithm used to estimate the maximum signal position of the surface point from the axial response

Note 1 to entry: The maximum signal (confocal peak) position is equated to the axial location of the surface.

Note 2 to entry: The confocal peak is not necessarily represented by the absolute maximum of the axial response; there are multiple algorithms (see [Annex B](#)).

### 3.16

#### **maximum measurable local slope**

<confocal microscopy> largest slope that can be measured on an optically smooth surface

Note 1 to entry: See ISO 25178-600:2019, Annex A.

### 3.17

#### **confocal stack**

series of optical sections taken during an axial scan

### 3.18

#### **confocal topography image**

areal topography image derived from a stack of optical sections obtained during an axial scan

Note 1 to entry: Generally, for each pixel of the image the *confocal peak location algorithm* ([3.15](#)) is applied to the *confocal stack* ([3.17](#)) to calculate the height of the surface.

3.19

**confocal intensity image**

areal intensity image derived from a stack of optical sections obtained during an axial scan

Note 1 to entry: For each pixel of the image an algorithm is applied that finds the reflected intensity of the surface. The applied algorithm might be different from the algorithm (3.15) to find the height of the surface.

Note 2 to entry: Such a group of images typically shows a depth of field close to the axial scan range.

**4 Descriptions of the influence quantities**

Influence quantities for confocal microscopy instruments are given in Table 2. The table indicates the metrological characteristics (see ISO 25178-600:2019, Table 1) affected by deviations in the influence quantities.

**Table 2 — Influence quantities for confocal microscopy**

Component	Element	Influence quantities	Metrological characteristic affected
Light source	$\lambda_0$	Measurement optical wavelength (see ISO 25178-600)	$\alpha_z$
	$B_{\lambda 0}$	Measurement optical bandwidth (ISO 25178-600)	$\alpha_z$
Microscope imaging system	$A_N$	Microscope numerical aperture (see ISO 25178-600)	$\alpha_x, \alpha_y, \alpha_z, W_R$
	$M_{IMG}$	Magnification between object sizes on the surface and image sizes on the sensor	$\alpha_x, \alpha_y$
	$\Delta_{PATH}$	Optical aberrations – a function describing net deviations in the measured optical path of the system, derived from imperfections in the optics and the topography of the flatness calibration surface	$\alpha_z$
	$Q_{OPT}$	General quality of the optical components used, including aberrations, transmission and alignment errors	$\alpha_x, \alpha_y, \alpha_z, z_{FLT}, l_x, l_y, l_z, W_R, \Delta_x, \Delta_y$
	$P_{DIS_{xy}}$	Lateral distortion of the magnified image on the camera	$\alpha_x, \alpha_y, \alpha_z, z_{FLT}, l_x, l_y, l_z, W_R, \Delta_x, \Delta_y$
	$U_{I(x,y)}$	Illumination uniformity – distribution of illumination across the field of view of the object (a highly uniform, constant distribution is desired)	$\alpha_x, \alpha_y, \alpha_z, z_{FLT}, l_x, l_y, l_z$
<sup>a</sup> These influence quantities arise from the interaction between the instrument and the sample being measured.			